

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHE-CHENG CHANG	01/20/2014
CHANG-YIN CHEN	01/20/2014
JR-JUNG LIN	01/28/2014
CHIH-HAN LIN	01/28/2014
YUNG JUNG CHANG	01/20/2014
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK,
City:	HSINCHU
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14163302
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NAME OF SUBMITTER:	PIN PIN HUANG
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DATE SIGNED:	03/17/2014
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, I(we), CHANG, CHE-CHENG, CHEN, CHANG-YIN, LIN, JR-JUNG, LIN, CHIH-HAN and CHANG, YUNG JUNG, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

SEMICONDUCTOR STRUCTURE AND MANUFACTURING METHOD THEREOF

(hereinafter referred to as the INVENTION) for which an application for United States Letters Patent /Utility Patent is executed on even date herewith unless at least one of the following is checked:

☐ United States Design Patent was

☐ executed on:

☒ filed on: 24 January 2014 Serial No.: 14/163,302

☐ established by PCT International Patent Application No.: filed: designating the

United States of America

☐ issued on _____ as U.S. Patent No.: _____

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD., whose post office address is NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK, HSINCHU, TAIWAN, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.

ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Assignor Name CHANG, CHE-CHENG	Address 8F., NO.17, XINXING ST., DANSHUI DIST., NEW TAIPEI CITY 251, TAIWAN, R.O.C.
Signature of Assignor <i>Chang Che Cheng</i>	Date of Signature 2014/01/20
Name of Witness (optional) <i>Chang Che Cheng</i>	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name CHEN, CHANG-YIN	Address 1F., NO.43, SEC. 4, XINYI RD., DA-AN DIST., TAIPEI CITY 106, TAIWAN, R.O.C.
Signature of Assignor <i>Chen Chang-Yin</i>	Date of Signature 2014/01/20
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name LIN, JR-JUNG	Address 5F.-11, NO.188, GUANXIN RD., EAST DIST., HSINCHU CITY 300, TAIWAN, R.O.C.
Signature of Assignor <i>Lin Jr Jung</i>	Date of Signature 2014/1/28
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name LIN, CHIH-HAN	Address RM. 12, 11F., NO.188, GUANXIN RD. EAST DIST., HSINCHU CITY 30072 TAIWAN, R.O.C.
Signature of Assignor <i>Lin Chih-Han</i>	Date of Signature 2014.1.128
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name CHANG, YUNG JUNG	Address NO. 47, GUANGFU ST., CYONGLIN TOWNSHIP, HSINCHU COUNTY, TAIWAN, R.O.C.
Signature of Assignor <i>Chang, Yung Jung</i>	Date of Signature 2014.01.20
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)